

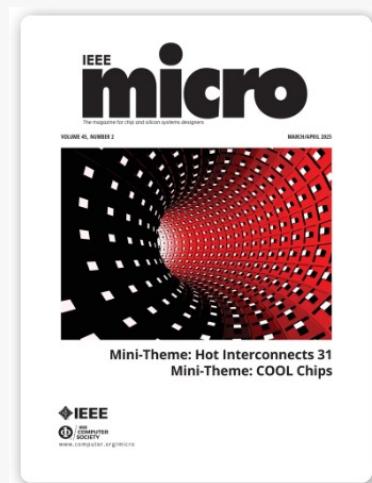


SPONSORSHIP PLANS 2026

Hot Interconnects

IEEE Hot Interconnects is the **premier international forum** for researchers and developers of state-of-the-art hardware and software architectures and implementations for **interconnection networks** of all scales.

Industry and academic leaders participate in the conference to engage with experts who are leading advancements in this area.



Home / Magazines / IEEE Micro / 2025.02
IEEE Micro
Special Issue on Hot Interconnects 31
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Keywords

<https://hoti.org/>



HotI Publications

Peer-reviewed publications:

- Two paper formats supported:
 - **Hot topic** short papers (3-4 pages)
 - **Full length** papers (10 pages)
- HOTI papers published to **IEEE Xplore** ([HOTI proceedings](#))
- A **best paper** award in **industry** and **academia** categories
- Selected papers published in **IEEE Micro** ([2024 edition here](#))

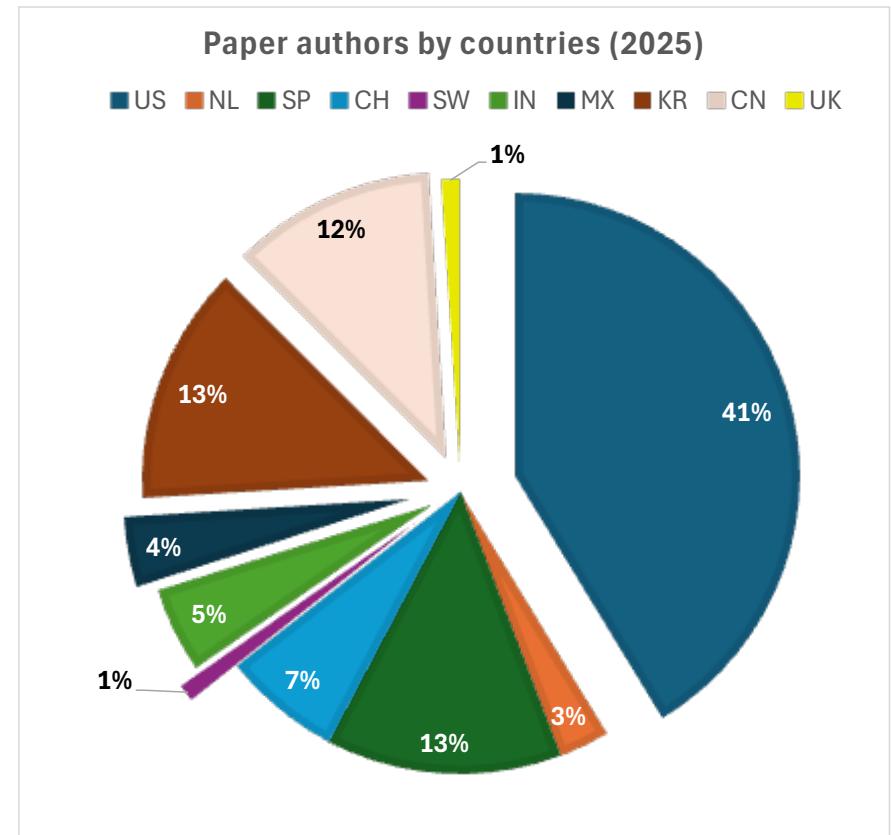


Statistics and Rankings:

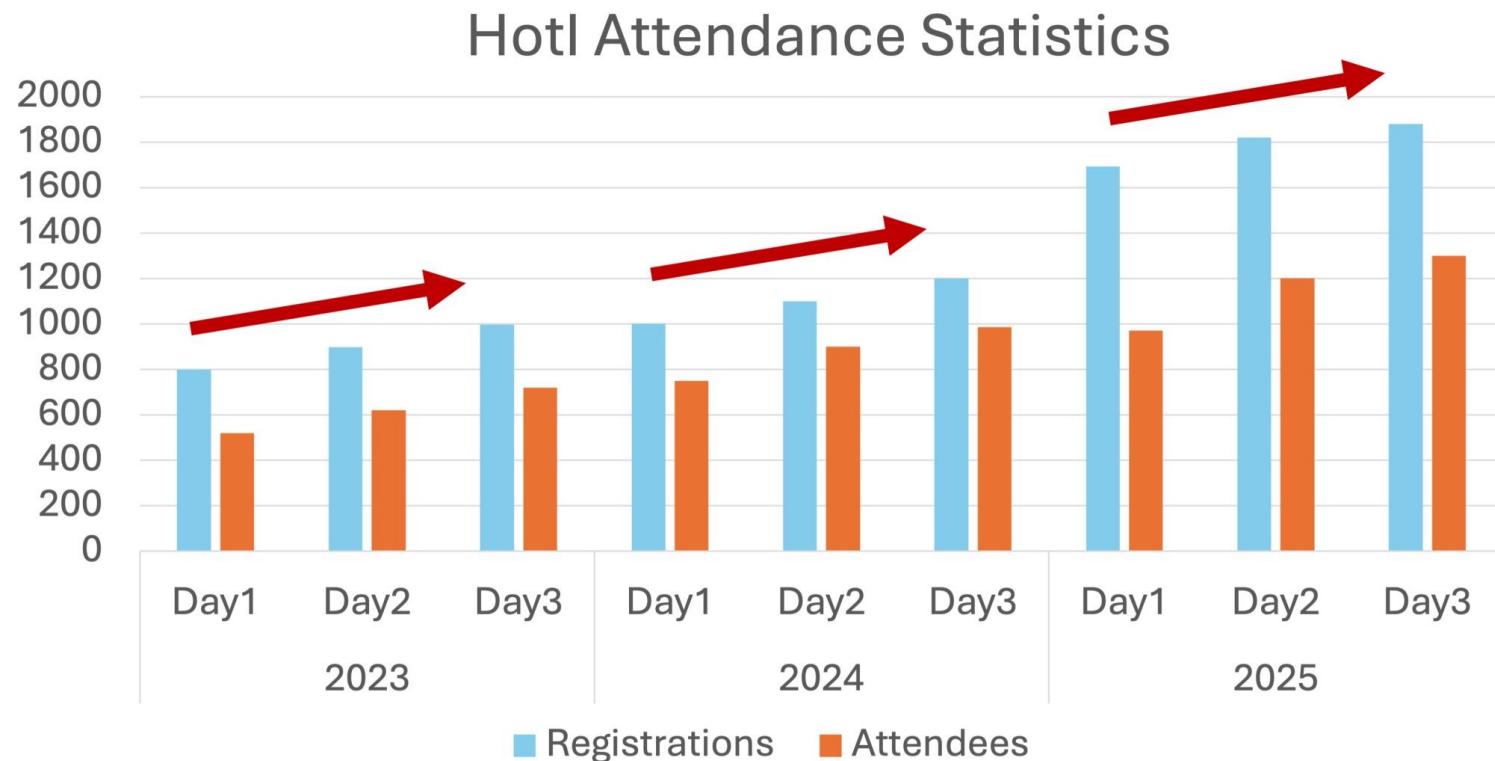
- LiveSHINE and Microsoft Academic give HOTI an **A ranking w/ 19-20 average citations per paper**.
- DBLP reports an average of **36 citations per paper** ([see live DBLP database query here](#)).
- ICORE ranks with approximately a **B citation ranking** ([ICORE HOTI](#), [CORE2023 citations](#)).

HOTI 2025 Technical Content

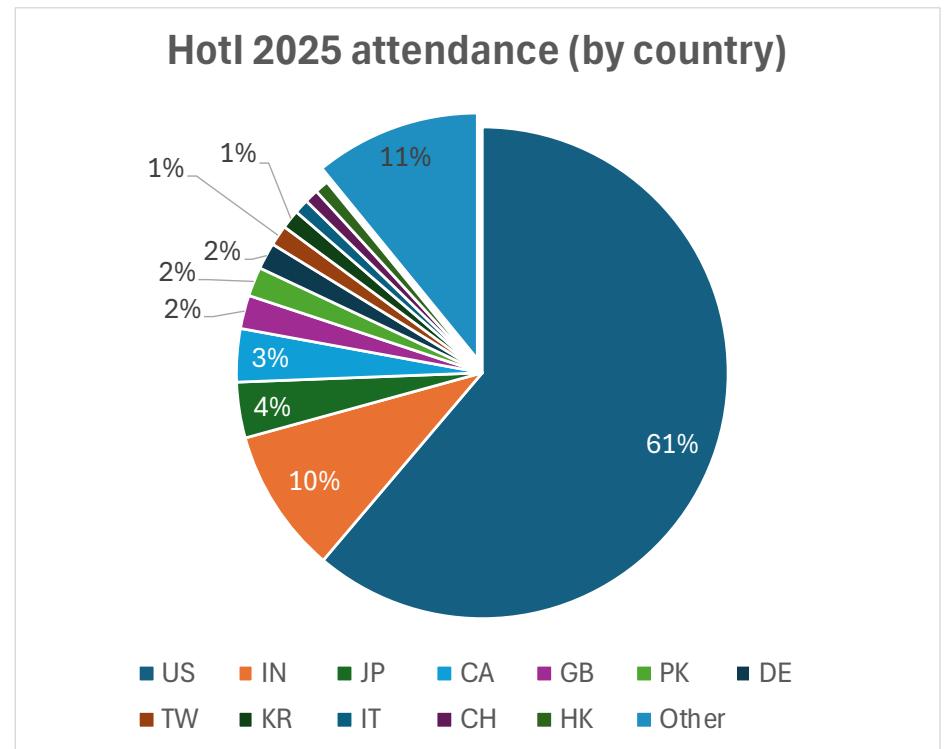
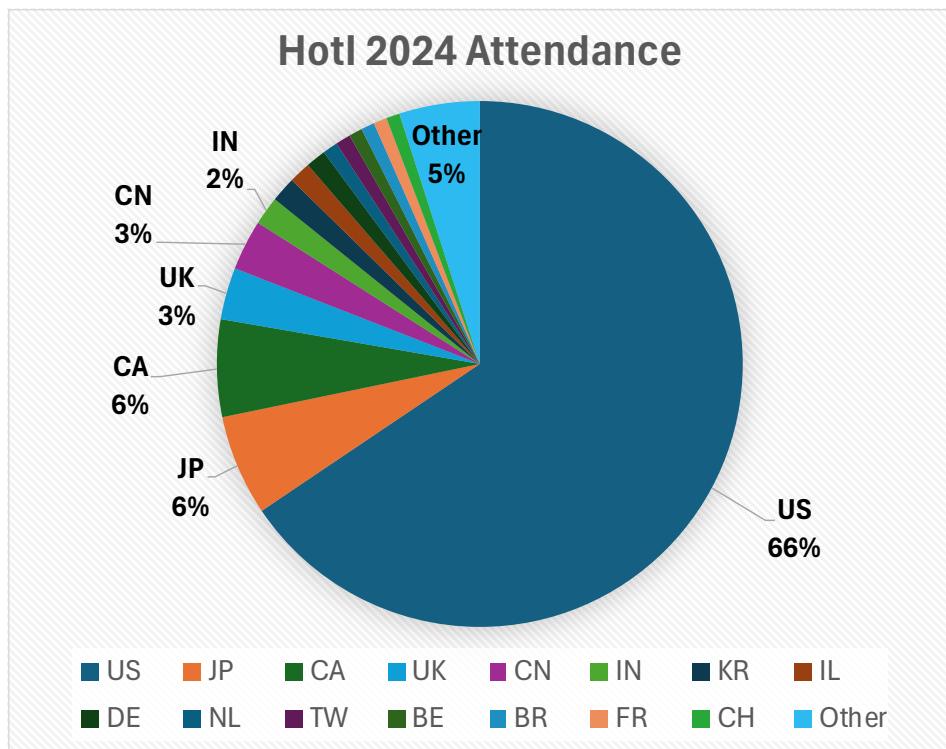
- HotI'25 **Technical Program Committee (TPC)**
 - **31 members**
 - From
 - **19 organizations** (37% Academia, 63% Industry)
 - France, Japan, South Korea, Spain, Switzerland, and US
- **Peer review process**
 - 4 reviews/paper
 - 9 Papers accepted
 - 8 full papers
 - 1 short hot-topic paper
 - Overall acceptance rate of 39%
- **Dedicated tutorials day**
 - Hands-on sessions from industry experts!



HOTI 2023-2025 attendance



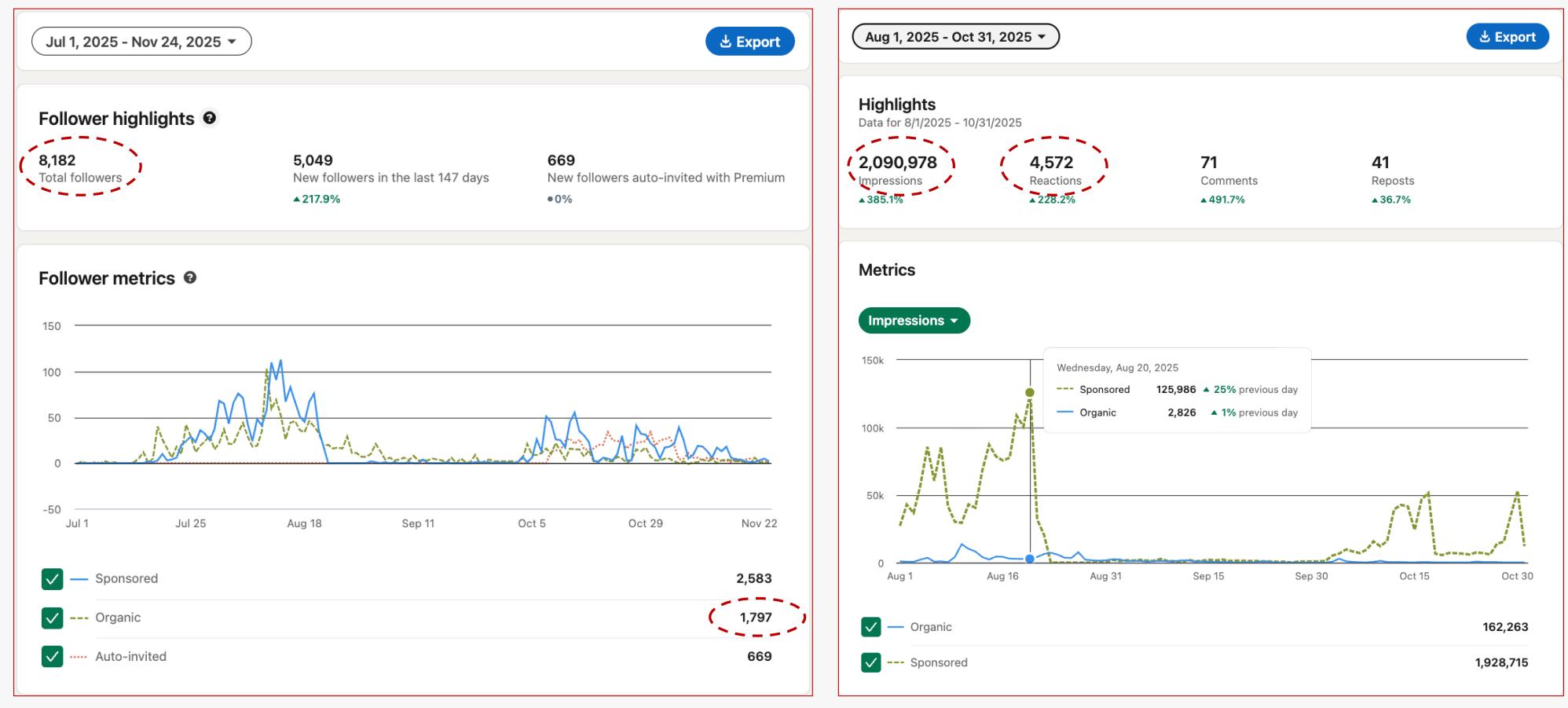
HOTI 2024/2025 attendance world-wide





Active LinkedIn presence

Organic growth (**8K+ followers**), active community (**thousands** of reactions, **millions** of impressions)

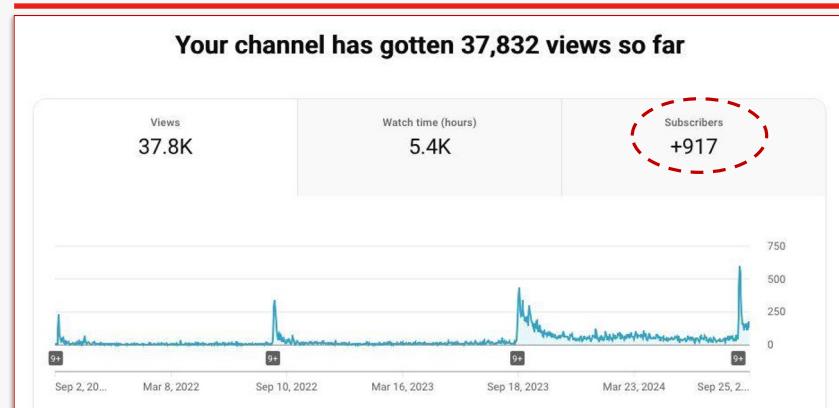




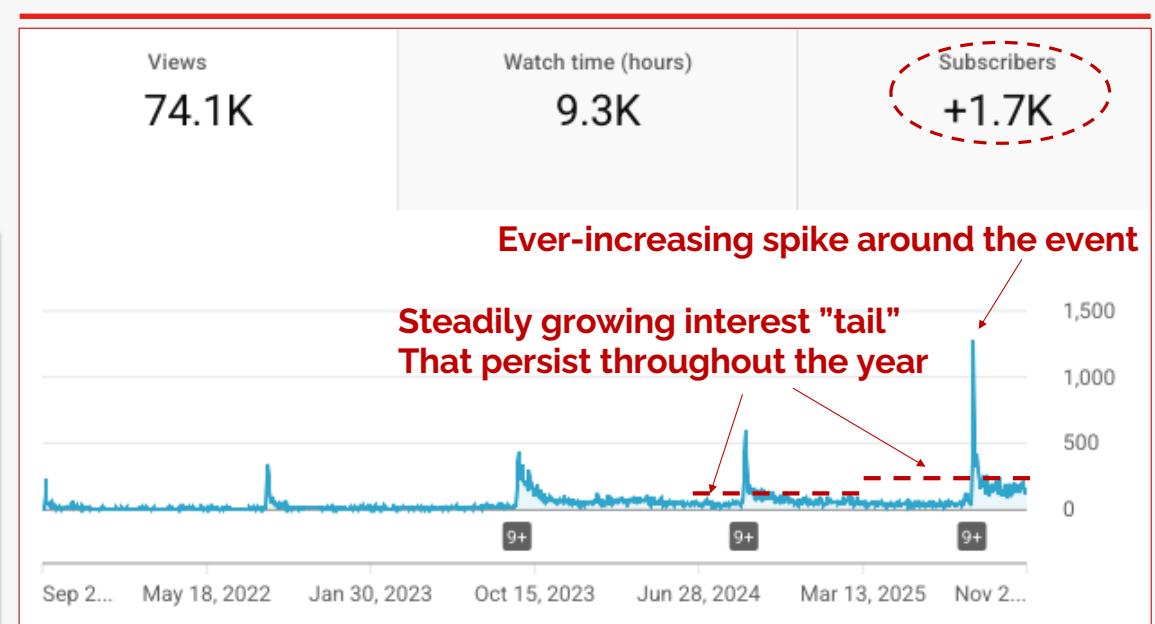
In-demand content (YouTube)

All Hotl talks are **recorded and published** on YouTube

2024



2025



Audience engagement

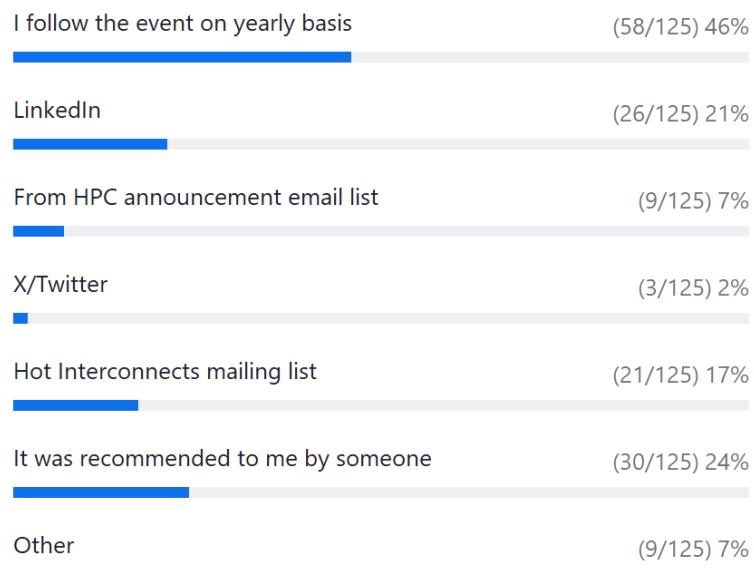
How did you hear about Hot-I?

Poll ended | 1 question | 125 total responses [\(i\)](#)

1. How did you learn about HotI this year?

(Multiple choice)

125/125 (100%) answered



Returning attendees

High impact from social media strategies

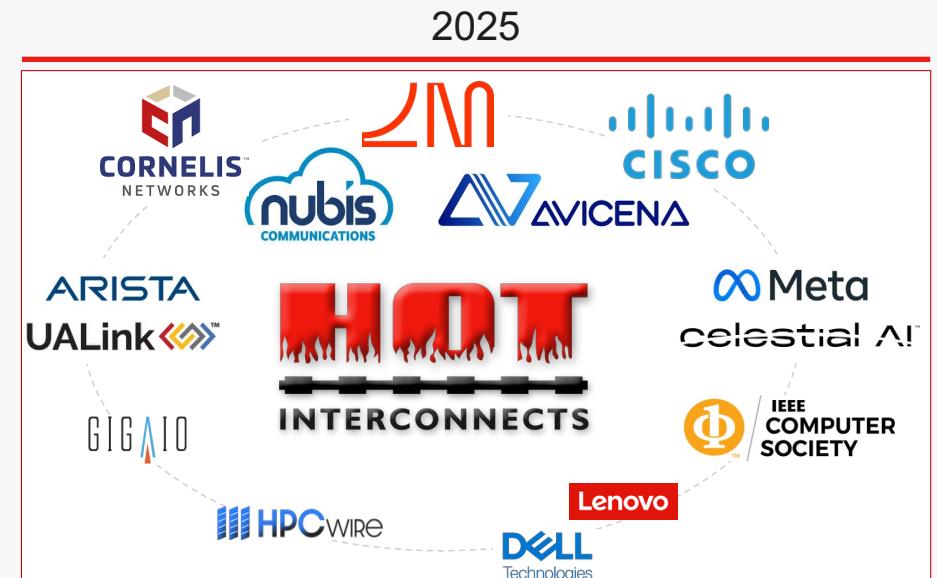
Leveraging community channels

Established communication

High impact of “word of mouth”



Increasing sponsorship interest





Hot 2025 in the News!

- Nvidia opens NVLink fabric to hyperscaler custom silicon,
sxdCentral: <https://www.sdxcentral.com/news/nvidia-opens-nvlink-fabric-to-hyperscaler-custom-silicon/>
- Google Is Already Using The Future AI Network You Might Get In 2028
The Next Platform: <https://www.nextplatform.com/2025/08/21/google-is-already-using-the-future-ai-network-you-might-get-in-2028/>
- Hot Interconnects: Arista Outlines Pathways to Energy-Efficient Optics and Liquid-Cooled Racks
Converge Digest: <https://convergedigest.com/hot25-arista-outlines-pathways-to-energy-efficient-optics-and-liquid-cooled-racks/?amp=1>
- Evolving Interconnect Fabric and SDN in the Cloud to Meet the Needs of AI
Segment Routing: <https://www.segment-routing.net/conferences/2025-08-20-hoti-symposium-2025/>
- Hot Interconnects: Meta Highlights 600K GPUs, Custom Chips, Next-Gen Fabrics
Converge Digest: <https://convergedigest.com/hot25-meta-highlights-600k-gpus-custom-chips-next-gen-fabrics/?amp=1>
- Hot Interconnects: Microsoft Maps Out \$100B AI Networking Fabric
Converge Digest: <https://convergedigest.com/hot25-microsoft-maps-out-100b-ai-networking-fabric/?amp=1>
- HOTI25: Lightmatter's Roadmap to 100x AI Bandwidth
Converge Digest: <https://convergedigest.com/hot-interconnects-lightmatters-roadmap-to-100x-ai-bandwidth/>
- Nvidia opens NVLink fabric to hyperscaler custom silicon
Data Center Dynamics (DCD): <https://www.datacenterdynamics.com/en/news/nvidia-opens-nvlink-fabric-to-hyperscaler-custom-silicon/>
- What's Up with HPC Interconnects? A Q&A with HotI
HPCwire: <https://www.hpcwire.com/2025/10/07/whats-up-with-hpc-interconnects-a-qa-with-hoti/>



2026 Conference Theme

Scale-Up, Scale-Out, Scale-Across: Do they really differ?

Complex high-capacity training and disaggregated inference workloads are being scaled-across multiple sites, blurring the lines between contemporary scale-out and scale-up interconnection stacks. All the classical issues such as jitter, bursts, flow/congestion, long-tail latencies, etc. are amplified over long distances, requiring deliberate interventions across the full interconnection stack: algorithms, operational tools, communication frameworks, and network fabrics. This edition of Hot Interconnects will explore these interventions behind operationalizing interconnects over long, short and shorter distances.



SPONSORSHIP LEVELS 2026

For levels with limited sponsorship slots, allocation is **first-come, first-served**.

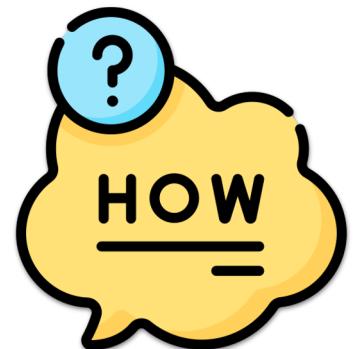
Level	# of slots	Cost	Speaking Slot Time	Sponsor Logo Size (website/event)	Email Distribution (59K recipients)	Recording	Social media
Diamond	3	\$5000	15 min		<input checked="" type="checkbox"/>	<input checked="" type="checkbox"/>	More prominent
Platinum	5	\$3500	10 min		<input checked="" type="checkbox"/>	<input checked="" type="checkbox"/>	▼
Gold	Unlimited	\$2000	N/A		<input checked="" type="checkbox"/>	<input checked="" type="checkbox"/>	▼
Silver	Unlimited	\$1000	N/A		<input checked="" type="checkbox"/>	<input checked="" type="checkbox"/>	Less prominent



HOW TO BECOME A SPONSOR

Becoming a sponsor:

- Step 1. Select a sponsorship level
- Step 2. Send an email to: sponsor@hoti.org
- Step 3. Make sponsor payment



Benefits:

- A **dedicated presentation slot** (recording or live) during the conference with a targeted audience interested in network interconnect technologies
- **Sponsor logos** displayed during conference (in breaks)
- Logo displayed on the website throughout 2026 (starting from the time of becoming a sponsor)
- **Advertisements** on official Hot Interconnects social media channels (LinkedIn, X/Twitter and Facebook)
- **Attendance statistics** provided after the event per request.



Thank you!

Questions? sponsor@hoti.org